

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7185683

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEIWEI QIU	01/18/2022
WEI LI	01/18/2022
LIANG CAI	01/18/2022
SHUAI ZHANG	01/18/2022
DINGWEN ZHANG	01/18/2022
RECEIVING PARTY DATA	
Name:	HANGZHOU QULIAN TECHNOLOGY CO., LTD.
Street Address:	ROOM 2001, BUILDING A, BUILDING 2
Internal Address:	NO. 399 DANFENG ROAD, BINJIANG DISTRICT
City:	HANGZHOU
State/Country:	CHINA
Postal Code:	310051
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17676155
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	310-497-0181
Email:	cliffordchiapc@outlook.com
Correspondent Name:	CLIFFORD CHI, A.P.C.
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Address Line 4:	ALHAMBRA, CALIFORNIA 91803
ATTORNEY DOCKET NUMBER:	136-ZP21729243US
NAME OF SUBMITTER:	CLIFFORD CHI
SIGNATURE:	/CLIFFORD CHI/
DATE SIGNED:	02/20/2022
Total Attachments: 3	

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COMBINED OATH/DECLARATION/ASSIGNMENT OF INVENTION

ASSIGNMENT

For valuable consideration, We,

[Weiwei QIU] of [Room 2001, Building A, Building 2, No. 399, Danfeng Road, Binjiang District, Hangzhou, Zhejiang 310051, China],

[Wei LI] of [Room 2001, Building A, Building 2, No. 399, Danfeng Road, Binjiang District, Hangzhou, Zhejiang 310051, China],

[Liang CAI] of [Room 2001, Building A, Building 2, No. 399, Danfeng Road, Binjiang District, Hangzhou, Zhejiang 310051, China],

[Shuai ZHANG] of [Room 2001, Building A, Building 2, No. 399, Danfeng Road, Binjiang District, Hangzhou, Zhejiang 310051, China],

[Dingwen ZHANG] of [Room 2001, Building A, Building 2, No. 399, Danfeng Road, Binjiang District, Hangzhou, Zhejiang 310051, China],

(hereinafter referred to as "Assignor")

hereby assign to [HANGZHOU QULIAN TECHNOLOGY CO., LTD.], [a limited liability company] and having a place of business at [Room 2001, Building A, Building 2, No. 399, Danfeng Road, Binjiang District, Hangzhou, Zhejiang 310051, China], and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the invention and improvements which are the subject of an application for United States Patent filed _____, U.S. Application No. _____ entitled [SMART CONTRACT PROCESSING METHOD AND SYSTEM, COMPUTER DEVICE, AND READABLE STORAGE MEDIUM], and related applications and patents, this assignment including said application, any and all United States and foreign patents granted for any of said inventions or improvements, including all divisions, continuations, reissues, continuations-in-part and extensions thereof, and the right to claim priority based on the filing date of said application and based on the filing date of any provisional application of which said application claims the benefit under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I/we authorize the Assignee to apply in all countries in my/our name/names or in its own name for patents and like

rights of exclusion and for inventor's certificates for said inventions and improvements; and I/we agree for myself/ourselves and my/our heirs, legal representatives and assigns, without further compensation, upon request to perform such lawful acts, to promptly provide Assignee with all pertinent facts and documents relating to said invention or application as may be known and accessible to me/us, to testify in any interference or litigation related to said invention or application and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

The Assignor hereby covenants that no assignment, sale, agreement, or encumbrance has been or will be made or entered into which would conflict with this Agreement.

OATH/DECLARATION

The above identified application was made or authorized to be made by me/us, the Assignor of this invention.

I/We, the Assignor, believe that I am/we are the original inventor or an original joint inventor of a claimed invention in the application.

I/We have reviewed and understand the contents of the application and am/are aware of the duty to disclose, to the United States Patent and Trademark Office, all information that is material to patentability of the invention.

I/We, the Assignor, hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Signed and Accepted by:

Weiwei QIU
[Weiwei QIU]

January 18, 2022
Date

Wei LI
[Wei LI]

January 18, 2022
Date

Liang CAI
[Liang CAI]

January 18, 2022
Date

Shuai ZHANG
[Shuai ZHANG]

January 18, 2022
Date

Dingwen ZHANG
[Dingwen ZHANG]

January 18, 2022
Date